

In Re the Application of:

QING MA, ET AL.

Application No.:

09/661,899

Filed:

September 14, 2000

For:

PROCESS FOR FORMING A DIRECT BUILD-UP LAYER ON AN ENCAPSULATED DIE PACKAGE AND

INTERMEDIATE STRUCTURES FORMED

THEREWITH

Art Group: 2814

Examiner: A. Chambliss

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In accordance with the duty of disclosure under 37 CFR § 1.56 and in accordance with 37 C.F.R. § 1.97, enclosed is a copy of Information Disclosure Citation Form PTO-1449 together with copies of the documents cited on that form. It is respectfully requested that the cited documents be considered and that the enclosed copy of the Information Disclosure Citation Form PTO-1449 be initialed by the Examiner to indicate such consideration and a copy thereof returned to applicant(s).

Pursuant 37 CFR § 1.97(e)(2), it is hereby stated that no item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned after making reasonable inquiry, no item of information contained in the Information Disclosure Statement was known to any individual designated in 1.56(c) more than three months prior to the filing of the Information Disclosure Statement.

Pursuant to 37 C.F.R. § 1.97, the submission of this Information Disclosure Statement is not to be construed as a representation that a search has been made and is not to be construed as an admission that the information cited in this statement is material to patentability.

Please charge any additional fee due to Deposit Account 02-2666. A duplicate copy of the Fee Transmittal is enclosed for this purpose.

		Respectfully submitted,
Date:	September 04, 2001	BLAKELY SOKOLOFF, TAYLOR & ZAFMAN LLP
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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 to the Patent and Trademark Office on: <u>September 4, 2001</u>.

Deborah L. Higham Date